

# **General Description**

The AAT8113 low threshold 20V, P-Channel MOS-FET is a member of AnalogicTech™'s TrenchDMOS<sup>™</sup> product family. Using an ultra-high density proprietary TrenchDMOS technology the AAT8113 is designed for use as a load switch in battery powered applications and protection in battery packs.

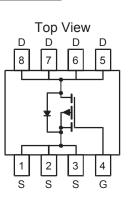
# **Features**

- $V_{DS(MAX)} = -20V$   $I_{D(MAX)}^{1} = -10A @ 25^{\circ}C$ Low  $R_{DS(ON)}$ : 14 m $\Omega$  @  $V_{GS} = -4.5V$ 
  - 24 m $\Omega \otimes V_{GS}$  = -2.5V

# **SOP-8L Package**

# **Applications**

- **Battery Packs**
- Battery-powered portable equipment



# Preliminary Information

## **Absolute Maximum Ratings** (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Description	Value	Units		
V <sub>DS</sub>	Drain-Source Voltage		-20	V	
V <sub>GS</sub>	Gate-Source Voltage		±12		
۱ <sub>D</sub>	Continuous Drain Current @ T <sub>J</sub> =150°C <sup>1</sup>	T <sub>A</sub> = 25°C	±10		
		T <sub>A</sub> = 70°C	±8	А	
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>		±48	A	
I <sub>s</sub>	Continuous Source Current (Source-Drain Diode) 1		-1.8		
P <sub>D</sub>	Maximum Power Dissipation <sup>1</sup>	T <sub>A</sub> = 25°C	2.5	W	
		T <sub>A</sub> = 70°C	1.6	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature Range		-55 to 150	°C	

# **Thermal Characteristics**

Symbol	Description	Value	Units	
R <sub>θJA</sub>	A Typical Junction-to-Ambient steady state <sup>1</sup>			
R <sub>0JA2</sub>	Maximum Junction-to-Ambient t<10 seconds <sup>1</sup>		°C/W	
R <sub>θJF</sub>	Typical Junction-to-Foot 1	23		



Symbol	Description	Conditions	Min	Тур	Max	Units	
DC Charac	DC Characteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =-250µA	-20			V	
D	Drain-Source ON-Resistance <sup>2</sup>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A		11	14	mΩ	
R <sub>DS(ON)</sub>		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-8A	18 24		11152		
I <sub>D(ON)</sub>	On-State Drain Current <sup>2</sup>	V <sub>GS</sub> =-4.5V, V <sub>DS</sub> =5V (Pulsed)	-48			A	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250µA	-0.6			V	
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	nA	
I	Drain Source Leakage Current	V <sub>GS</sub> =0V, V <sub>DS</sub> =-20V	-1		-1		
I <sub>DSS</sub>		V <sub>GS</sub> =0V, V <sub>DS</sub> =-16V, T <sub>J</sub> =70°C <sup>3</sup>			-5 µA		
9 <sub>fs</sub>	Forward Transconductance <sup>2</sup>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-10A		31		S	
Dynamic C	haracteristics <sup>3</sup>						
$Q_{G}$	Total Gate Charge	V <sub>DS</sub> =-10V, R <sub>D</sub> =1.0Ω, V <sub>GS</sub> =-4.5V		36			
$Q_{GS}$	Gate-Source Charge	V <sub>DS</sub> =-10V, R <sub>D</sub> =1.0Ω, V <sub>GS</sub> =-4.5V		5		nC	
$Q_{GD}$	Gate-Drain Charge	V <sub>DS</sub> =-10V, R <sub>D</sub> =1.0Ω, V <sub>GS</sub> =-4.5V		14.5			
t <sub>D(ON)</sub>	Turn-ON Delay	$V_{DS}$ =-10V, $R_{D}$ =1.0 $\Omega$ , $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$		30			
t <sub>R</sub>	Turn-ON Rise Time	$V_{DS}$ =-10V, $R_{D}$ =1.0 $\Omega$ , $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$		76		ns	
t <sub>D(OFF)</sub>	Turn-OFF Delay	$V_{DS}$ =-10V, $R_{D}$ =1.0 $\Omega$ , $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$		94		115	
t <sub>F</sub>	Turn-OFF Fall Time	$V_{DS}$ =-10V, $R_{D}$ =1.0 $\Omega$ , $V_{GS}$ =-4.5V, $R_{G}$ =6 $\Omega$		88			
Source-Dra	Source-Drain Diode Characteristics						
$V_{SD}$	Source-Drain Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0, I <sub>S</sub> =-10A			-1.2	V	
۱ <sub>s</sub>	Continuous Diode Current <sup>1</sup>				-1.8	A	

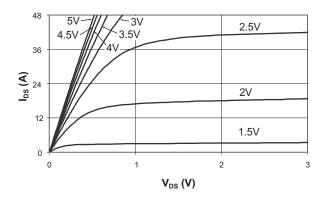
Note 1: Based on thermal dissipation from junction to ambient while mounted on a 1" x 1" PCB with optimized layout. A 10 second pulse on a 1" x 1" PCB approximates testing a device mounted on a large multi-layer PCB as in most applications.  $R_{\theta JF} + R_{\theta FA} = R_{\theta JA}$  where the foot thermal reference is defined as the normal solder mounting surface of the device's leads.  $R_{\theta JF}$  is guaranteed by design, however  $R_{\theta CA}$  is determined by the PCB design. Actual maximum continuous current is limited by the application's design.

Note 2: Pulse test: Pulse Width = 300 µs

Note 3: Guaranteed by design. Not subject to production testing.

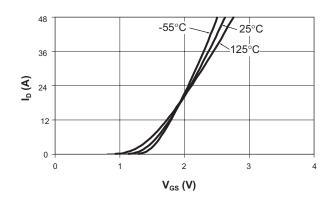


# **Typical Characteristics**

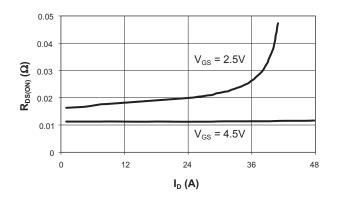


### **Output Characteristics**

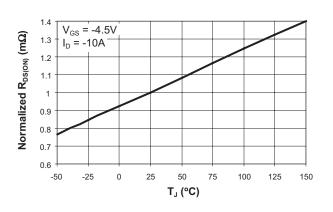
**Transfer Characteristics** 



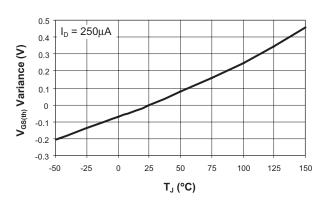
**On-Resistance vs. Drain Current** 



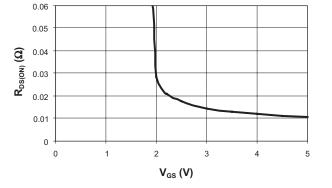
**On-Resistance vs. Junction Temperature** 



Threshold Voltage



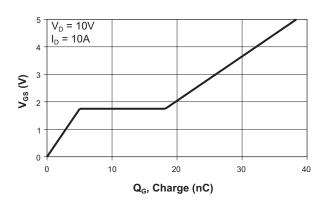
On-Resistance vs. Gate to Source Voltage



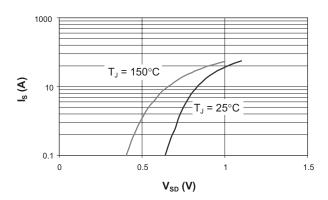


# AAT8113 20V P-Channel Power MOSFET

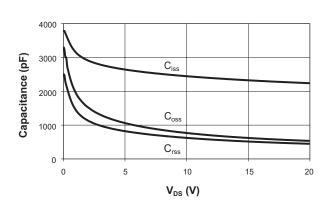
# **Typical Characteristics**



### Gate Charge



# Capacitance



### Source-Drain Diode Forward Voltage

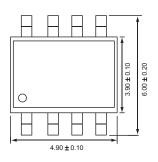


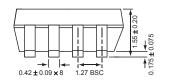
# **Ordering Information**

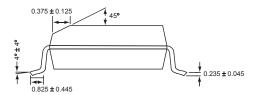
Package	Marking	Part Number (Tape and Reel)
SOP-8	8113	AAT8113IAS-T1

# Package Information

SOP-8







All dimensions in millimeters.



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